



CJDR9112 Motor Driver

1 Introduction

CJDR9112 is a low input voltage, full bridge motor driver chip. It can work in the power supply voltage range of 2.0 ~ 6.0V, and can provide continuous output current up to 1.1A. It has PWM (IN / IN) interface compatible with industry standard equipment, and integrates undervoltage protection and thermal shutdown protection internally. Therefore, CJDR9112 is very suitable for applications requiring low input voltage or battery power, such as cameras, toys and other consumer electronics.

2 Available Package

| PART NUMBER | PACKAGE |
|-------------|-------------|
| CJDR9112 | DFNWB2×2-8L |

Note: For more detailed packaging information, see the part *Pin Configuration and Function* and the part *Mechanical Information*.

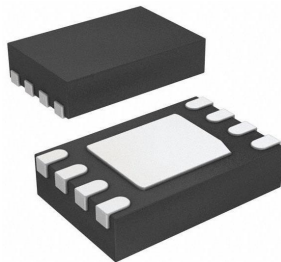


Figure 2-1. DFNWB2×2-8L Package

3 Features

- H-Bridge Motor Driver
- Power Supply Voltage: 2.0 ~ 6.0V
- Low Conductivity Impedance: 480mΩ (HS + LS)
- Output Current: 1.1A (Continuously)
- PWM (IN 1 / IN 2) Input Mode
- Over Temperature Protection
- Undervoltage Protection
- Low Current Sleep Mode: nA level, IN 1= IN 2 = 0

4 Applications

- Digital Single Lens Reflex (DSLR) Lens
- Electric Toothbrush
- Medical Equipment
- Robotics
- Shared Bicycle Lock
- Toys
- Video Camera
- Water Gas Meter Switch

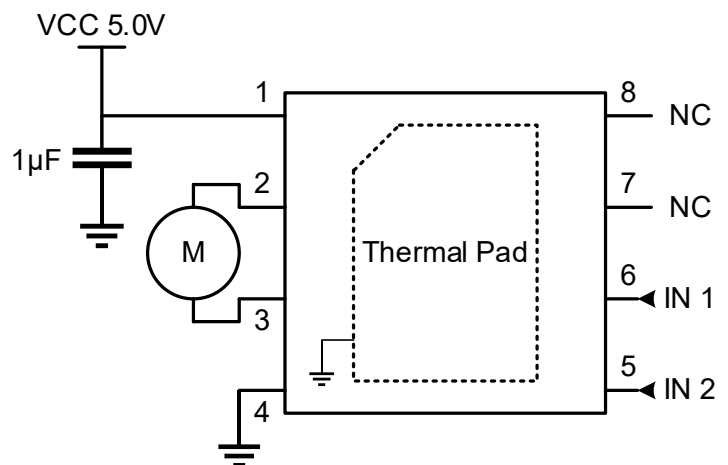


Figure 4-1. Typical Application Circuit

5 Pin Configuration and Function

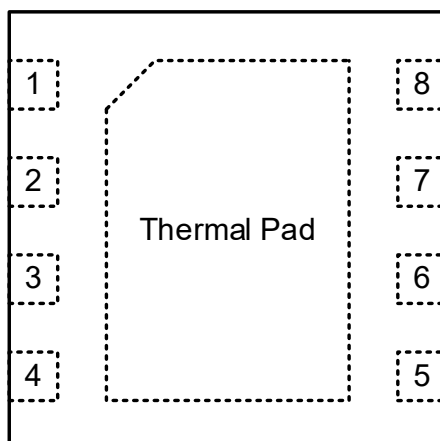


Figure 5-1. Package Top View

| PIN NAME | CJDR9112 | I / O | DESCRIPTION |
|----------|-------------|--------|--|
| | DFNWB2×2-8L | | |
| VCC | 1 | Power | Logic power supply. |
| OUT 1 | 2 | O | H-bridge output 1. |
| OUT 2 | 3 | O | H-bridge output 2. |
| GND | 4 | Ground | Device ground. Connect to system ground. |
| IN 2 | 5 | I | H-bridge control input 2. |
| IN 1 | 6 | I | H-bridge control input 1. |
| NC | 7 & 8 | - | Not connected. |
| - | Thermal Pad | - | Connect to system ground. |

6 Specifications

6.1 Absolute Maximum Ratings⁽¹⁾

(over operating free-air temperature range, unless otherwise specified)

| CHARACTERISTIC | | | SYMBOL | VALUE | UNIT |
|--|----------|-------------|----------------------|-----------------------------------|------|
| Power supply input voltage ⁽²⁾ | | | V _{CC} | -0.3 ~ 7 | V |
| Logic pin input voltage(IN x) ⁽²⁾ | | | V _{IN x} | -0.5 ~ 7 | |
| Maximum peak current | | | I _{OUT MAX} | 2.2 | A |
| Maximum power dissipation | CJDR9112 | DFNWB2x2-8L | P _{D Max} | Internally Limited ⁽³⁾ | W |
| Maximum junction temperature | | | T _{J Max} | 150 | °C |
| Storage temperature | | | T _{stg} | -60 ~ 150 | °C |
| Soldering temperature & time | | | T _{solder} | 260°C, 10s | - |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to network ground terminal.

(3) Refer to *Thermal Information* for details.

6.2 Recommended Operating Conditions⁽⁴⁾

| PARAMETER | SYMBOL | MIN. | NOM. | MAX. | UNIT |
|--------------------------------|-------------------|------|------|--------------------|------|
| Power supply input voltage | V _{CC} | 2.0 | - | 6.0 | V |
| Logic input voltage (IN x) | V _{IN x} | 0 | - | 7.0 | V |
| Continuous output current | I _{OUT} | 0 | - | 1.1 | A |
| PWM frequency | f _{PWM} | 0 | - | 250 | kHz |
| Operating junction temperature | T _J | -40 | - | 150 | °C |
| Operating ambient temperature | T _A | -40 | - | 100 ⁽⁵⁾ | °C |

(4) JSCJ recommends that users should not exceed the rated value in the *Recommended Operating Conditions* for the application conditions of the equipment, so as to ensure the stability of normal operation and reliability of long term operation of the equipment. Operation beyond the recommended rated conditions does not mean that the product will fail. The consumers need to evaluate the risks that may be caused by the operation of the product beyond the recommended rated conditions.

(5) It is necessary to ensure that the operating junction temperature of the equipment does not exceed the rated value of the recommended operating conditions when using the device for design.

6 Specifications

6.3 ESD Ratings

| ESD RATINGS | | SYMBOL | VALUE | UNIT |
|--|------------------|---------------|-------|------|
| Electrostatic discharge ⁽⁶⁾ | Human body model | $V_{ESD-HBM}$ | 3000 | V |

(6) ESD testing is conducted in accordance with the relevant specifications formulated by the Joint Electronic Equipment Engineering Commission (JEDEC). The human body model (HBM) electrostatic discharge test is based on the JESD22-114D test standard, using a 100pF capacitor and discharging to each pin of the device through a resistance of 1.5kΩ.

6.4 Thermal Information

| THERMAL METRIC ⁽⁷⁾ | SYMBOL | CJDR9112 | UNIT |
|---|-----------------|-----------|------|
| | | DFN2x2-8L | |
| Junction-to-ambient thermal resistance | $R_{\theta JA}$ | 140.0 | °C/W |
| Maximum heat dissipation power for continuous operation | $P_{D Ref}$ | 0.90 | W |

(7) $T_A = 25^\circ\text{C}$, all numbers are typical, and apply for packages soldered directly onto a PCB board in still air.

6 Specifications

6.5 Electrical Characteristics

CJDR9112 ($V_{CC} = 5.0V$, $T_A = 25^\circ C$, unless otherwise specified)

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | MIN. | TYP. ⁽⁸⁾ | MAX. | UNIT | |
|---|------------------|---|---------------|---------------------|------|------------|---|
| Power Supply | | | | | | | |
| Power supply voltage | V_{CC} | - | 2.0 | 5.0 | 6.0 | V | |
| Power supply current 1 | I_{VCC} | $V_{CC} = 5V$, without PWM | - | 200 | 550 | μA | |
| Power supply current 2 | I_{VCCQ} | $V_{CC} = 5V$, IN 1 = IN 2 = 0V, power saving mode | - | 0.01 | 1.0 | μA | |
| Output H-bridge Parameters | | | | | | | |
| High + Low bridge conduction resistance | $R_{DS\ ON}$ | $V_{CC} = 5V$, $I_{OUT} = 500mA$ | - | 480 | 600 | m Ω | |
| Off leakage current | I_{OFF} | $V_{OUT} = 0V$ | -200 | - | 200 | nA | |
| Logic Input Pin (IN 1, IN 2) | | | | | | | |
| Input logic low voltage | V_{IL} | High level to low level | $V_{CC} = 3V$ | 0 | - | 0.75 | V |
| | | | $V_{CC} = 5V$ | 0 | - | 1.0 | |
| Input logic high voltage | V_{IH} | Low level to high level | $V_{CC} = 3V$ | 1.3 | - | V_{CC} | V |
| | | | $V_{CC} = 5V$ | 2.1 | - | V_{CC} | |
| Input logic hysteresis | V_{HY} | $V_{CC} = 3V$ | - | 0.4 | - | V | |
| | | $V_{CC} = 5V$ | - | 0.6 | - | | |
| Logic low input current | I_{IL} | $V_{IN\ x} = 0V$ | -5 | - | 5 | μA | |
| Logic high input current | I_{IH} | $V_{IN\ x} = 3.3V$ | - | 350 | - | μA | |
| Pull down resistance | R_{PD} | - | - | 100 | - | k Ω | |
| Thermal Shutdown Protection | | | | | | | |
| Thermal shutdown | T_{SD} | - | 150 | 170 | 180 | $^\circ C$ | |
| Thermal shutdown hysteresis | ΔT_{SD} | - | - | 30 | - | $^\circ C$ | |
| Undervoltage Locking | | | | | | | |
| Undervoltage locking voltage | V_{ULO} | Supply rising | - | 2.0 | - | V | |
| Undervoltage locking hysteresis | ΔV_{ULO} | Supply falling | - | 200 | - | mV | |

Note:

(8) Typical numbers are at 25 $^\circ C$ and represent the most likely norm.

6 Specifications

6.6 Time Series Parameters

CJDR9112 ($V_{CC} = 5.0V$, $T_A = 25^\circ C$, $R_L = 20\Omega$, unless otherwise specified)

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | MIN. | TYP. ⁽⁸⁾ | MAX. | UNIT |
|---------------------------------|--------|-----------------|------|---------------------|------|------|
| Start-up time | T1 | - | - | 600 | - | ns |
| Shutdown time | T2 | - | - | 180 | 220 | ns |
| Input high to output high delay | T3 | - | - | 160 | 200 | ns |
| Input low to output low delay | T4 | - | - | 10 | 100 | ns |
| Output rising edge time | T5 | - | - | 35 | 188 | ns |
| Output drop edge time | T6 | - | - | 10 | 188 | ns |

Not:

(8) Typical numbers are at 25°C and represent the most likely norm.

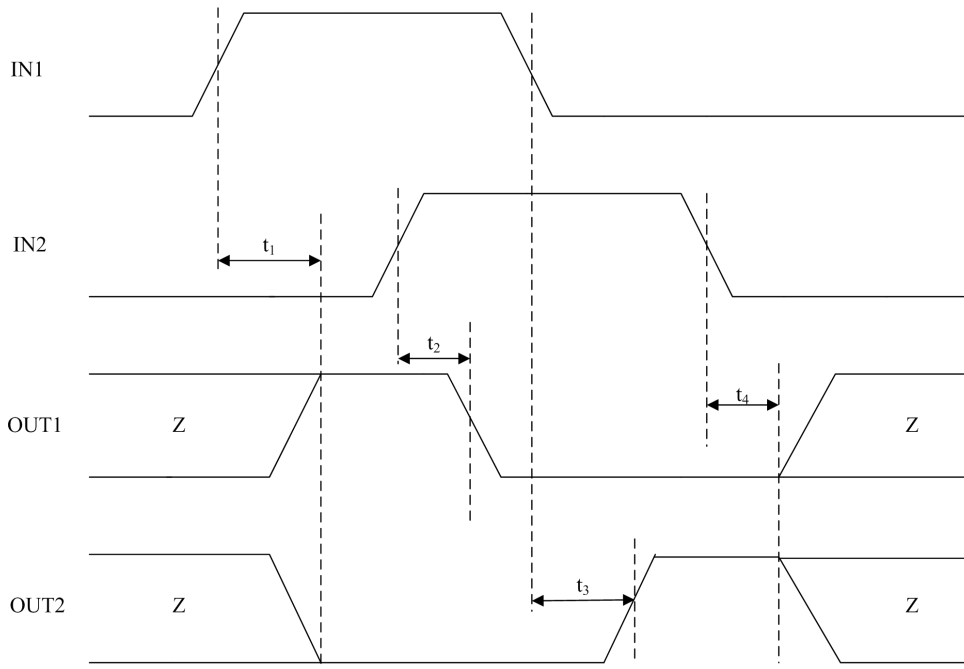


Figure 6-1. Input and Output Time Parameter 1

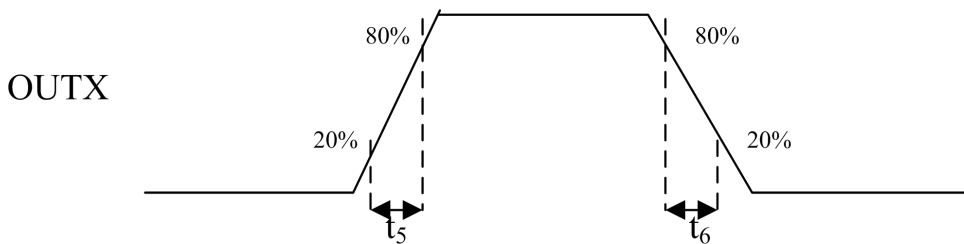


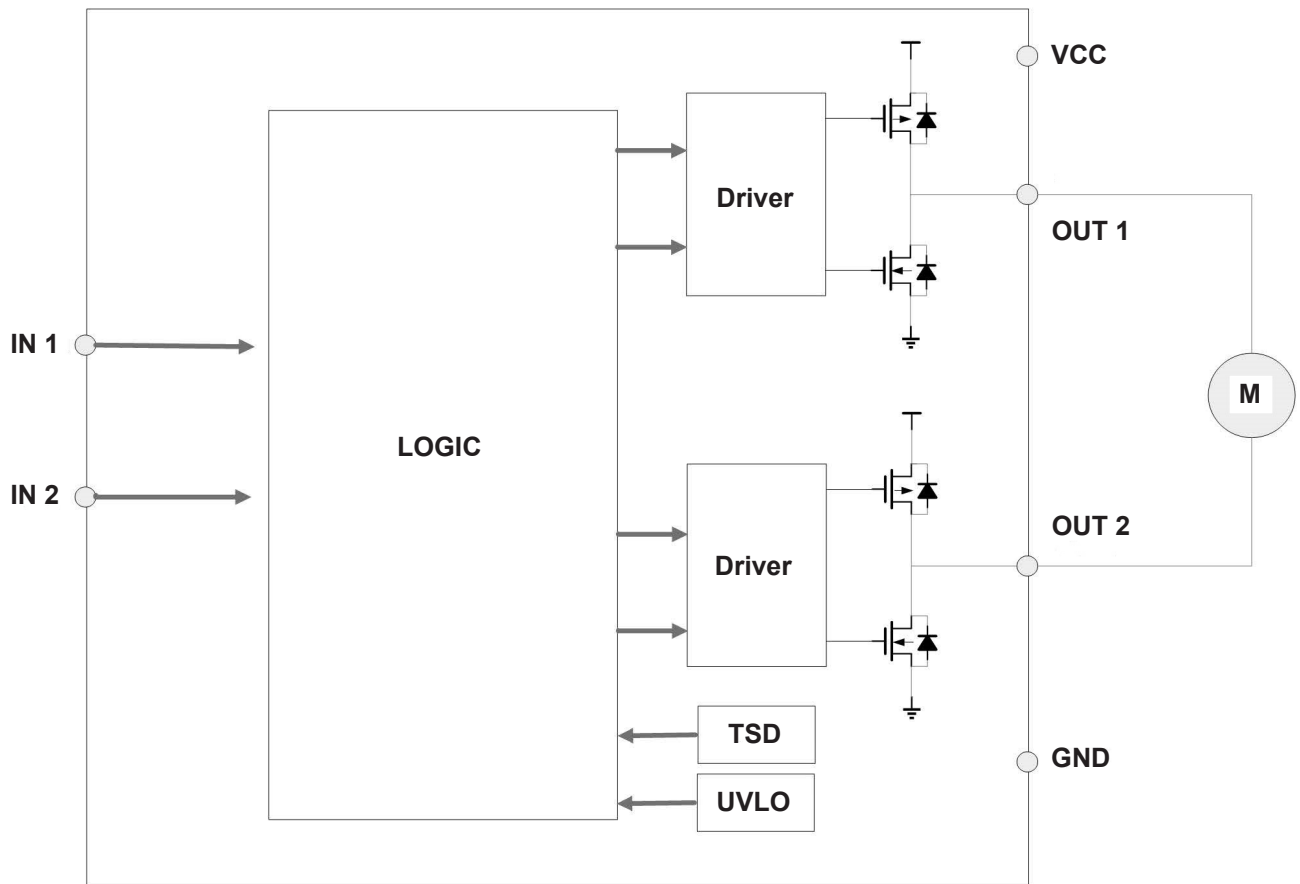
Figure 6-2. Input and Output Time Parameter 2

7 Detailed Description

7.1 Description

CJDR9112 is a single-channel full-bridge driver that provides up to 1.1A continuous output current and can operate at 1.2 ~ 6.0V power supply voltage. CJDR9112 has industry standard compatible PWM (IN / IN) input interface, and has thermal shutdown protection functions.

7.2 Functional Block Diagram



7 Detailed Description

7.3 Feature Description

PWM Control Mode

CJDR9112 is controlled by PWM input interface, also known as IN / IN input mode, the PWM interface (IN 1 / IN 2) controls the OUT x pins according to the logic table in Table 7-1.

Table 7-1. PWM Control Mode with Automatic Sleep

| IN 1 | IN 2 | OUT 1 | OUT 2 | DESCRIPTION |
|------|------|-------|-------|--|
| 0 | 0 | Hi-Z | Hi-Z | Coast (H-bridge Hi-Z) / low-power automatic sleep mode |
| 0 | 1 | L | H | Reverse (OUT 2 → OUT 1) |
| 1 | 0 | H | L | Forward (OUT 1 → OUT 2) |
| 1 | 1 | L | L | Brake (low-side slow decay) |

Output Driver

Since the V_{GS} of the driving power supply of the output driver tube is related to the power supply, the H-bridge output conduction resistance of the CJDR9112 decreases with the increase of the voltage, so the current capacity of the chip decreases at low voltage.

Sleep Mode

When IN 1 and IN 2 are low at the same time, the chip works normal.

When IN 1 = IN 2 = 0, the chip enters a low-power sleep mode, the internal circuit stops working, and the total current is less than 1 μ A.

Input Pin

IN 1 and IN 2 input pins have 100k Ω resistance pull-down, and the default is low level.

Over Temperature Protection

When the chip junction temperature exceeds 170 $^{\circ}$ C , the over temperature protection circuit is activated and all output tubes are turned off. When the temperature decreases by a hysteresis temperature of 30 $^{\circ}$ C to 140 $^{\circ}$ C , the output tube returns to work. However, because the over temperature protection is activated only when the chip junction temperature exceeds the set value, it does not guarantee that the product will be protected from damage with this circuit.

Under-voltage Locking

When the chip power supply voltage is lower than 2.0V (Typ.), the internal detection circuit will turn off the H-bridge output. If the voltage recovers, the output turns on again when it rises to 2.2V (Typ.).

7 Detailed Description

7.3 Feature Description (continued)

Operation Mode

CJDR9112 enters the sleep mode when IN 1 = IN 2 is low. In the sleep mode, all h bridges are turned off and output high resistance state. Most circuits of chip circuits are turned off and enter the power saving mode. When IN 1 and IN 2 are not low at the same time, they will automatically resume normal operation.

When the over temperature protection detects failure, it will also close the H-bridge.

Table 7-2. Operation Mode

| MODE | CONDITION | H-BRIDGE |
|-------------------|------------------------------------|------------------|
| Work | 0 when IN 1 is different from IN 2 | Normal Operation |
| Sleep mode | IN 1 = IN 2 = 0 | Shutdown |
| Failure detection | IN x = X | Shutdown |

8 Application and Implementation

8.1 Typical Application Circuit

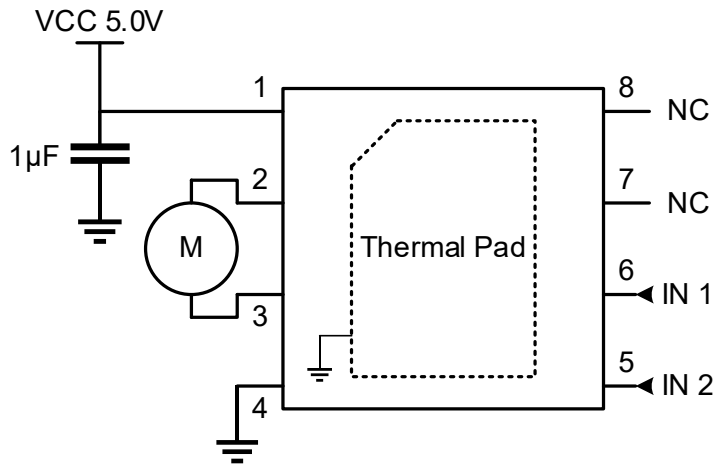


Figure 8-1. Typical Application Circuit

8.2 Application Information

The absolute parameters of the chip cannot be exceeded in any environment.

The bypass capacitor of V_{CC} , especially the connection of ceramic capacitor, should be as close to the V_{CC} pin of the chip as possible.

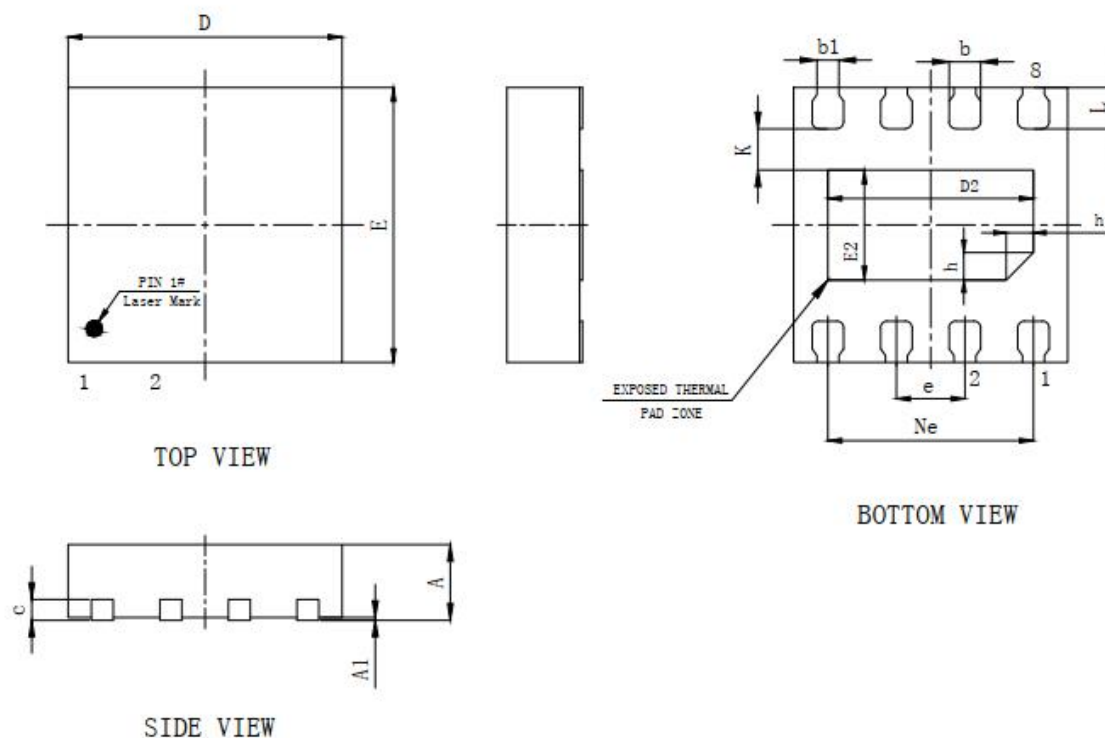
The ground wire connecting the motor needs to be isolated in layout design.

NOTE

The application information in this section is not part of the data sheet component specification, and JSCJ makes no commitment or statement to guarantee its accuracy or completeness. Customers are responsible for determining the rationality of corresponding components in their circuit design and making tests and verifications to ensure the normal realization of their circuit design.

9 Mechanical Information

DFNWB2x2-8L Outline Dimensions (Unit: mm)



| SYMBOL | DISMENSIONS IN MILLIMETERS | | | DISMENSIONS IN INCHES | | |
|--------------------|----------------------------|-------|-------|-----------------------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.500 | 0.550 | 0.600 | 0.020 | 0.022 | 0.024 |
| A1 | 0.000 | 0.020 | 0.050 | 0.000 | 0.001 | 0.002 |
| b | 0.180 | 0.230 | 0.280 | 0.007 | 0.009 | 0.011 |
| b1 | 0.110 | 0.160 | 0.210 | 0.004 | 0.006 | 0.008 |
| c | 0.100 | 0.150 | 0.200 | 0.004 | 0.006 | 0.008 |
| D | 1.900 | 2.000 | 2.100 | 0.075 | 0.079 | 0.083 |
| D2 | 1.400 | 1.500 | 1.600 | 0.055 | 0.020 | 0.063 |
| e | 0.500 Bsc. | | | 0.020 Bsc. | | |
| Ne | 1.500 Bsc. | | | 0.059 Bsc. | | |
| E | 1.900 | 2.000 | 2.100 | 0.075 | 0.079 | 0.083 |
| E2 | 0.700 | 0.800 | 0.900 | 0.028 | 0.031 | 0.035 |
| L | 0.250 | 0.300 | 0.350 | 0.010 | 0.012 | 0.014 |
| h | 0.150 | 0.200 | 0.250 | 0.006 | 0.008 | 0.010 |
| K | 0.250 | 0.300 | 0.350 | 0.010 | 0.012 | 0.014 |
| L / F Carrier Size | 1.750 × 1.150 | | | 0.069 × 0.045 | | |

10 Notes and Revision History

10.1 Associated Product Family and Others

To view other products of the same type or IC products of other types, click the official website of JSCJ -- <https://www.jscj-elec.com> for more details.

10.2 Notes

Electrostatic Discharge Caution



This IC may be damaged by ESD. Relevant personnel shall comply with correct installation and use specifications to avoid ESD damage to the IC. If appropriate measures are not taken to prevent ESD damage, the hazards caused by ESD include but are not limited to degradation of integrated circuit performance or complete damage of integrated circuit. For some precision integrated circuits, a very small parameter change may cause the whole device to be inconsistent with its published specifications.

10.3 Revision History

June, 2022: released CJDR9112 rev - 1.0.

DISCLAIMER

IMPORTANT NOTICE, PLEASE READ CAREFULLY

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